Renesas Electronics America Inc - R5F562T6EDFM#V1 Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	I²C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	37
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f562t6edfm-v1

Table 1.5 List of Pins and Pin Functions (100-Pin LQFP) (3 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi-cation	Interrupt	POE	Debugging
77		P60	AN0					
78		P55	AN11					
79		P54	AN10					
80		P53	AN9					
81		P52	AN8					
82		P51	AN7					
83		P50	AN6					
84		P47	AN103/ CVREFH					
85		P46	AN102					
86		P45	AN101					
87		P44	AN100					
88		P43	AN003/ CVREFL					
89		P42	AN002					
90		P41	AN001					
91		P40	AN000					
92	AVCC0							
93	VREFH0							
94	VREFL0							
95	AVSS0							
96		P82		MTIC5U	SCK2-B			
97		P81		MTIC5V	TXD2-B			
98		P80		MTIC5W	RXD2-B			
99		P11		MTCLKC-B		IRQ1-A		
100		P10		MTCLKD-B		IRQ0-A		

Table 1.7 List of Pins and Pin Functions (80-Pin LQFP: R5F562TxGDFF) (3 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communication	Interrupt	POE	Debugging
76	AVSS0							
77		P82		MTIC5U	SCK2-B			
78		P81		MTIC5V	TXD2-B			
79		P80		MTIC5W	RXD2-B			
80		P10		MTCLKD-B		IRQ0-A		

Table 1.8 List of Pins and Pin Functions (64-Pin LQFP) (2 / 2)

Pin No. (64-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi-cation	Interrupt	POE	Debuggi ng
40		P33		MTIOC3A/ MTCLKA-A	SSL3-A			
41		P32		MTIOC3C/ MTCLKB-A	SSL2-A			
42	VCC							
43		P31		MTIOC0A-B/ MTCLKC-A	SSL1-A			
44	VSS							
45		P30		MTIOC0B-B/ MTCLKD-A	SSL0-A			
46		P24			RSPCK-A			
47		P23			CTX-B/ LTX/ MOSI-A			
48		P22			CRX-B/ LRX/ MISO-A			
49		P47	AN103/ CVREFH					
50		P46	AN102					
51		P45	AN101					
52		P44	AN100					
53		P43	AN003/ CVREFL					
54		P42	AN002					
55		P41	AN001					
56		P40	AN000					
57	AVCC0							
58	VREFH0							
59	VREFL0							
60	AVSS0							
61		P11		MTCLKC-B		IRQ1-A		
62		P10		MTCLKD-B		IRQ0-A		
63		PA5	ADTRG1#-A	MTIOC1A	MISO-B			
64		PA4	ADTRG0#-A	MTIOC1B	RSPCK-B			

(9) Accumulator (ACC)

The accumulator (ACC) is a 64-bit register used for DSP instructions. The accumulator is also used for the multiply and multiply-and-accumulate instructions; EMUL, EMULU, FMUL, MUL, and RMPA, in which case the prior value in the accumulator is modified by execution of the instruction.

Use the MVTACHI and MVTACLO instructions for writing to the accumulator. The MVTACHI and MVTACLO instructions write data to the higher-order 32 bits (bits 63 to 32) and the lower-order 32 bits (bits 31 to 0), respectively.

Use the MVFACHI and MVFACMI instructions for reading data from the accumulator. The MVFACHI and MVFACMI instructions read data from the higher-order 32 bits (bits 63 to 32) and the middle 32 bits (bits 47 to 16), respectively.

(4) Number of Access Cycles to I/O Registers

The number of access cycles to I/O registers is obtained by following equation.*

Number of access cycles to I/O registers = Number of bus cycles for internal main bus 1 +
Number of divided cycles for clock synchronization +
Number of bus cycles for internal peripheral buses 1, 2, 4, and 6

The number of bus cycles for internal peripheral buses 1, 2, 4, and 6 differs according to the register to be accessed. For the number of access cycles to each I/O register, see Table 4.1, List of I/O Registers.

When peripheral functions connected to internal peripheral bus 6 are accessed, the number of divided cycles for clock synchronization is added.

Although the number of divided cycles for clock synchronization differs depending on the number of frequency ratio between ICLK and PCLK or bus access timing, the sum of the number of bus cycles for internal main bus 1 and the number of divided cycles for clock synchronization will be one PCLK at a maximum. Therefore, one PCLK is added to the number of access cycles shown in Table 4.1.

Note: • This applies to the number of cycles when the access from the CPU does not conflict with the instruction fetching to the external memory or bus access from the different bus master (DTC).

Table 4.1 List of I/O Registers (Address Order) (5 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 7172h	ICU	DTC activation enable register 114	DTCER114	8	8	2 ICLK
0008 7173h	ICU	DTC activation enable register 115	DTCER115	8	8	2 ICLK
0008 7174h	ICU	DTC activation enable register 116	DTCER116	8	8	2 ICLK
0008 7175h	ICU	DTC activation enable register 117	DTCER117	8	8	2 ICLK
0008 7179h	ICU	DTC activation enable register 121	DTCER121	8	8	2 ICLK
0008 717Ah	ICU	DTC activation enable register 122	DTCER122	8	8	2 ICLK
0008 717Dh	ICU	DTC activation enable register 125	DTCER125	8	8	2 ICLK
0008 717Eh	ICU	DTC activation enable register 126	DTCER126	8	8	2 ICLK
0008 7181h	ICU	DTC activation enable register 129	DTCER129	8	8	2 ICLK
0008 7182h	ICU	DTC activation enable register 130	DTCER130	8	8	2 ICLK
0008 7183h	ICU	DTC activation enable register 131	DTCER131	8	8	2 ICLK
0008 7184h	ICU	DTC activation enable register 132	DTCER132	8	8	2 ICLK
0008 7186h	ICU	DTC activation enable register 134	DTCER134	8	8	2 ICLK
0008 7187h	ICU	DTC activation enable register 135	DTCER135	8	8	2 ICLK
0008 7188h	ICU	DTC activation enable register 136	DTCER136	8	8	2 ICLK
0008 7189h	ICU	DTC activation enable register 137	DTCER137	8	8	2 ICLK
0008 718Ah	ICU	DTC activation enable register 138	DTCER138	8	8	2 ICLK
0008 718Bh	ICU	DTC activation enable register 139	DTCER139	8	8	2 ICLK
0008 718Ch	ICU	DTC activation enable register 140	DTCER140	8	8	2 ICLK
0008 718Dh	ICU	DTC activation enable register 141	DTCER141	8	8	2 ICLK
0008 718Eh	ICU	DTC activation enable register 142	DTCER142	8	8	2 ICLK
0008 718Fh	ICU	DTC activation enable register 143	DTCER143	8	8	2 ICLK
0008 7190h	ICU	DTC activation enable register 144	DTCER144	8	8	2 ICLK
0008 7191h	ICU	DTC activation enable register 145	DTCER145	8	8	2 ICLK
0008 7195h	ICU	DTC activation enable register 149	DTCER149	8	8	2 ICLK
0008 7196h	ICU	DTC activation enable register 150	DTCER150	8	8	2 ICLK
0008 7197h	ICU	DTC activation enable register 151	DTCER151	8	8	2 ICLK
0008 7198h	ICU	DTC activation enable register 152	DTCER152	8	8	2 ICLK
0008 7199h	ICU	DTC activation enable register 153	DTCER153	8	8	2 ICLK
0008 71AEh	ICU	DTC activation enable register 174	DTCER174	8	8	2 ICLK
0008 71AFh	ICU	DTC activation enable register 175	DTCER175	8	8	2 ICLK
0008 71B0h	ICU	DTC activation enable register 176	DTCER176	8	8	2 ICLK
0008 71B1h	ICU	DTC activation enable register 177	DTCER177	8	8	2 ICLK
0008 71B2h	ICU	DTC activation enable register 178	DTCER178	8	8	2 ICLK
0008 71B3h	ICU	DTC activation enable register 179	DTCER179	8	8	2 ICLK
0008 71B4h	ICU	DTC activation enable register 180	DTCER180	8	8	2 ICLK
0008 71B5h	ICU	DTC activation enable register 181	DTCER181	8	8	2 ICLK
0008 71B6h	ICU	DTC activation enable register 182	DTCER182	8	8	2 ICLK
0008 71B7h	ICU	DTC activation enable register 183	DTCER183	8	8	2 ICLK
0008 71B8h	ICU	DTC activation enable register 184	DTCER184	8	8	2 ICLK
0008 71BAh	ICU	DTC activation enable register 186	DTCER186	8	8	2 ICLK
0008 71BBh	ICU	DTC activation enable register 187	DTCER187	8	8	2 ICLK
0008 71BCh	ICU	DTC activation enable register 188	DTCER188	8	8	2 ICLK
0008 71BDh	ICU	DTC activation enable register 189	DTCER189	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (11 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 8383h	RSPI	RSPI status register	SPSR	8	8	2, 3 PCLK*3
0008 8384h	RSPI	RSPI data register	SPDR	16, 32	16, 32	2, 3 PCLK*3
0008 8388h	RSPI	RSPI sequence control register	SPSCR	8	8	2, 3 PCLK*3
0008 8389h	RSPI	RSPI sequence status register	SPSSR	8	8	2, 3 PCLK*3
0008 838Ah	RSPI	RSPI bit rate register	SPBR	8	8	2, 3 PCLK*3
0008 838Bh	RSPI	RSPI data control register	SPDCR	8	8	2, 3 PCLK*3
0008 838Ch	RSPI	RSPI clock delay register	SPCKD	8	8	2, 3 PCLK*3
0008 838Dh	RSPI	RSPI slave select negation delay register	SSLND	8	8	2, 3 PCLK*3
0008 838Eh	RSPI	RSPI next-access delay register	SPND	8	8	2, 3 PCLK*3
0008 838Fh	RSPI	RSPI control register 2	SPCR2	8	8	2, 3 PCLK*3
0008 8390h	RSPI	RSPI command register 0	SPCMD0	16	16	2, 3 PCLK*3
0008 8392h	RSPI	RSPI command register 1	SPCMD1	16	16	2, 3 PCLK*3
0008 8394h	RSPI	RSPI command register 2	SPCMD2	16	16	2, 3 PCLK*3
0008 8396h	RSPI	RSPI command register 3	SPCMD3	16	16	2, 3 PCLK*3
0008 8398h	RSPI	RSPI command register 4	SPCMD4	16	16	2, 3 PCLK*3
0008 839Ah	RSPI	RSPI command register 5	SPCMD5	16	16	2, 3 PCLK*3
0008 839Ch	RSPI	RSPI command register 6	SPCMD6	16	16	2, 3 PCLK*3
0008 839Eh	RSPI	RSPI command register 7	SPCMD7	16	16	2, 3 PCLK*3
0008 9000h	S12AD0	A/D control register	ADCSR	8	8	2, 3 PCLK*3
0008 9004h	S12AD0	A/D channel select register	ADANS	16	16	2, 3 PCLK*3
0008 900Ah	S12AD0	A/D programmable gain amplifier register	ADPG	16	16	2, 3 PCLK*3
0008 900Eh	S12AD0	A/D control extended register	ADCER	16	16	2, 3 PCLK*3
0008 9010h	S12AD0	A/D start trigger select register	ADSTRGR	16	16	2, 3 PCLK*3
0008 9012h	S12AD	Comparator operating mode select register 0	ADCMPMD0	16	16	2, 3 PCLK*3
0008 9014h	S12AD	Comparator operating mode select register 1	ADCMPMD1	16	16	2, 3 PCLK*3
0008 9016h	S12AD	Comparator filter mode register 0	ADCMPNR0	16	16	2, 3 PCLK*3
0008 9018h	S12AD	Comparator filter mode register 1	ADCMPNR1	16	16	2, 3 PCLK*3
0008 901Ah	S12AD	Comparator detection flag register	ADCMPFR	8	8	2, 3 PCLK*3
0008 901Ch	S12AD	Comparator interrupt select register	ADCMPSEL	16	16	2, 3 PCLK*3
0008 901Eh	S12AD0	A/D data register Diag	ADRD	16	16	2, 3 PCLK*3
0008 9020h	S12AD0	A/D data register 0A	ADDR0A	16	16	2, 3 PCLK*3
0008 9022h	S12AD0	A/D data register 1	ADDR1	16	16	2, 3 PCLK*3
0008 9024h	S12AD0	A/D data register 2	ADDR2	16	16	2, 3 PCLK*3
0008 9026h	S12AD0	A/D data register 3	ADDR3	16	16	2, 3 PCLK*3
0008 9030h	S12AD0	A/D data register 0B	ADDR0B	16	16	2, 3 PCLK*3
0008 9060h	S12AD0	A/D sampling state register	ADSSTR	8	8	2, 3 PCLK*3
0008 9080h	S12AD1	A/D control register	ADCSR	8	8	2, 3 PCLK*3
0008 9084h	S12AD1	A/D channel select register	ADANS	16	16	2, 3 PCLK*3
0008 908Ah	S12AD1	A/D programmable gain amplifier register	ADPG	16	16	2, 3 PCLK*3
0008 908Eh	S12AD1	A/D control extended register	ADCER	16	16	2, 3 PCLK*3
0008 9090h	S12AD1	A/D start trigger select register	ADSTRGR	16	16	2, 3 PCLK*3
0008 909Eh	S12AD1	A/D data register Diag	ADRD	16	16	2, 3 PCLK*3
0008 90A0h	S12AD1	A/D data register 0A	ADDR0A	16	16	2, 3 PCLK*3
0008 90A2h	S12AD1	A/D data register 1	ADDR1	16	16	2, 3 PCLK*3

Table 4.1 List of I/O Registers (Address Order) (16 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0009 4019h	LIN0	Data 2 buffer register	L0DB2	8	8, 16, 32	2, 3 PCLK*3
0009 401Ah	LIN0	Data 3 buffer register	L0DB3	8	8, 16, 32	2, 3 PCLK*3
0009 401Bh	LIN0	Data 4 buffer register	L0DB4	8	8, 16, 32	2, 3 PCLK*3
0009 401Ch	LIN0	Data 5 buffer register	L0DB5	8	8, 16, 32	2, 3 PCLK*3
0009 401Dh	LIN0	Data 6 buffer register	L0DB6	8	8, 16, 32	2, 3 PCLK*3
0009 401Eh	LIN0	Data 7 buffer register	L0DB7	8	8, 16, 32	2, 3 PCLK*3
0009 401Fh	LIN0	Data 8 buffer register	L0DB8	8	8, 16, 32	2, 3 PCLK*3
000C 1200h	MTU3	Timer control register	TCR	8	8, 16, 32	5 ICLK
000C 1201h	MTU4	Timer control register	TCR	8	8	5 ICLK
000C 1202h	MTU3	Timer mode register 1	TMDR1	8	8, 16	5 ICLK
000C 1203h	MTU4	Timer mode register 1	TMDR1	8	8	5 ICLK
000C 1204h	MTU3	Timer I/O control register H	TIORH	8	8, 16, 32	5 ICLK
000C 1205h	MTU3	Timer I/O control register L	TIORL	8	8	5 ICLK
000C 1206h	MTU4	Timer I/O control register H	TIORH	8	8, 16	5 ICLK
000C 1207h	MTU4	Timer I/O control register L	TIORL	8	8	5 ICLK
000C 1208h	MTU3	Timer interrupt enable register	TIER	8	8, 16	5 ICLK
000C 1209h	MTU4	Timer interrupt enable register	TIER	8	8	5 ICLK
000C 120Ah	MTU	Timer output master enable register A	TOERA	8	8	5 ICLK
000C 120Dh	MTU	Timer gate control register A	TGCRA	8	8	5 ICLK
000C 120Eh	MTU	Timer output control register 1A	TOCR1A	8	8, 16	5 ICLK
000C 120Fh	MTU	Timer output control register 2A	TOCR2A	8	8	5 ICLK
000C 1210h	MTU3	Timer counter	TCNT	16	16, 32	5 ICLK
000C 1212h	MTU4	Timer counter	TCNT	16	16	5 ICLK
000C 1214h	MTU	Timer cycle data register A	TCDRA	16	16, 32	5 ICLK
000C 1216h	MTU	Timer dead time data register A	TDDRA	16	16	5 ICLK
000C 1218h	MTU3	Timer general register A	TGRA	16	16, 32	5 ICLK
000C 121Ah	MTU3	Timer general register B	TGRB	16	16	5 ICLK
000C 121Ch	MTU4	Timer general register A	TGRA	16	16, 32	5 ICLK
000C 121Eh	MTU4	Timer general register B	TGRB	16	16	5 ICLK
000C 1220h	MTU	Timer subcounter A	TCNTSA	16	16, 32	5 ICLK
000C 1222h	MTU	Timer cycle buffer register A	TCBRA	16	16	5 ICLK
000C 1224h	MTU3	Timer general register C	TGRC	16	16, 32	5 ICLK
000C 1226h	MTU3	Timer general register D	TGRD	16	16	5 ICLK
000C 1228h	MTU4	Timer general register C	TGRC	16	16, 32	5 ICLK
000C 122Ah	MTU4	Timer general register D	TGRD	16	16	5 ICLK
000C 122Ch	MTU3	Timer status register	TSR	8	8, 16	5 ICLK
000C 122Dh	MTU4	Timer status register	TSR	8	8	5 ICLK
000C 1230h	MTU	Timer interrupt skipping set register 1A	TITCR1A	8	8, 16	5 ICLK
000C 1231h	MTU	Timer interrupt skipping counter 1A	TITCNT1A	8	8	5 ICLK
000C 1232h	MTU	Timer buffer transfer set register A	TBTERA	8	8	5 ICLK
000C 1234h	MTU	Timer dead time enable register A	TDERA	8	8	5 ICLK
000C 1236h	MTU	Timer output level buffer register A	TOLBRA	8	8	5 ICLK
000C 1238h	MTU3	Timer buffer operation transfer mode register	TBTM	8	8, 16	5 ICLK
000C 1239h	MTU4	Timer buffer operation transfer mode register	TBTM	8	8	5 ICLK

Table 4.1 List of I/O Registers (Address Order) (23 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
000C 222Ch	GPT2	A/D converter start request timing register B	GTADTRB	16	16, 32	3 to 5 ICLK*4
000C 222Eh	GPT2	A/D converter start request timing buffer register B	GTADTBRB	16	16, 32	3 to 5 ICLK*4
000C 2230h	GPT2	A/D converter start request timing double-buffer register B	GTADTDBRB	16	16, 32	3 to 5 ICLK*4
000C 2234h	GPT2	General PWM timer output negate control register	GTONCR	16	16, 32	3 to 5 ICLK*4
000C 2236h	GPT2	General PWM timer dead time control register	GTDTCR	16	16, 32	3 to 5 ICLK*4
000C 2238h	GPT2	General PWM timer dead time value register	GTDVU	16	16, 32	3 to 5 ICLK*4
000C 223Ah	GPT2	General PWM timer dead time value register	GTDVD	16	16, 32	3 to 5 ICLK*4
000C 223Ch	GPT2	General PWM timer dead time buffer register	GTDBU	16	16, 32	3 to 5 ICLK*4
000C 223Eh	GPT2	General PWM timer dead time buffer register	GTDBD	16	16, 32	3 to 5 ICLK*4
000C 2240h	GPT2	General PWM timer output protection function status register	GTSOS	16	16, 32	3 to 5 ICLK*4
000C 2242h	GPT2	General PWM timer output protection temporary release register	GTSOTR	16	16, 32	3 to 5 ICLK*4
000C 2280h	GPT3	General PWM timer I/O control register	GTIOR	16	8, 16, 32	3 to 5 ICLK*4
000C 2282h	GPT3	General PWM timer interrupt output setting register	GTINTAD	16	8, 16, 32	3 to 5 ICLK*4
000C 2284h	GPT3	General PWM timer control register	GTCR	16	8, 16, 32	3 to 5 ICLK*4
000C 2286h	GPT3	General PWM timer buffer enable register	GTBER	16	8, 16, 32	3 to 5 ICLK*4
000C 2288h	GPT3	General PWM timer count direction register	GTUDC	16	8, 16, 32	3 to 5 ICLK*4
000C 228Ah	GPT3	General PWM timer interrupt and A/D converter start request skipping setting register	GTITC	16	8, 16, 32	3 to 5 ICLK*4
000C 228Ch	GPT3	General PWM timer status register	GTST	16	8, 16, 32	3 to 5 ICLK*4
000C 228Eh	GPT3	General PWM timer counter	GTCNT	16	16	3 to 5 ICLK*4
000C 2290h	GPT3	General PWM timer compare capture register A	GTCCRA	16	16, 32	3 to 5 ICLK*4
000C 2292h	GPT3	General PWM timer compare capture register B	GTCCRB	16	16, 32	3 to 5 ICLK*4
000C 2294h	GPT3	General PWM timer compare capture register C	GTCCRC	16	16, 32	3 to 5 ICLK*4
000C 2296h	GPT3	General PWM timer compare capture register D	GTCCRD	16	16, 32	3 to 5 ICLK*4
000C 2298h	GPT3	General PWM timer compare capture register E	GTCCRE	16	16, 32	3 to 5 ICLK*4
000C 229Ah	GPT3	General PWM timer compare capture register F	GTCCRF	16	16, 32	3 to 5 ICLK*4
000C 229Ch	GPT3	General PWM timer cycle setting register	GTPR	16	16, 32	3 to 5 ICLK*4
000C 229Eh	GPT3	General PWM timer cycle setting buffer register	GTPBR	16	16, 32	3 to 5 ICLK*4
000C 22A0h	GPT3	General PWM timer cycle setting double-buffer register	GTPDBR	16	16, 32	3 to 5 ICLK*4
000C 22A4h	GPT3	A/D converter start request timing register A	GTADTRA	16	16, 32	3 to 5 ICLK*4
000C 22A6h	GPT3	A/D converter start request timing buffer register A	GTADTBRA	16	16, 32	3 to 5 ICLK*4
000C 22A8h	GPT3	A/D converter start request timing double-buffer register A	GTADTDBRA	16	16, 32	3 to 5 ICLK*4
000C 22ACh	GPT3	A/D converter start request timing register B	GTADTRB	16	16, 32	3 to 5 ICLK*4
000C 22AEh	GPT3	A/D converter start request timing buffer register B	GTADTBRB	16	16, 32	3 to 5 ICLK*4
000C 22B0h	GPT3	A/D converter start request timing double-buffer register B	GTADTDBRB	16	16, 32	3 to 5 ICLK*4
000C 22B4h	GPT3	General PWM timer output negate control register	GTONCR	16	16, 32	3 to 5 ICLK*4

Table 4.2 List of I/O Registers (Bit Order) (11 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
SCI1	SEMR	—	—	NFEN	ABCS	—	—	—	—
SMCI1	SMR	GM	BLK	PE	PM	(BCP[1:0])		CKS[1:0]	
SMCI1	BRR								
SMCI1	SCR	TIE	RIE	TE	RE	MPIE	TEIE	CKE[1:0]	
SMCI1	TDR								
SMCI1	SSR	TDRE	RDRF	ORER	ERS	PER	TEND	MPB	MPBT
SMCI1	RDR								
SMCI1	SCMR	BCP2	—	—	—	SDIR	SINV	—	SMIF
SCI2	SMR	CM	CHR	PE	PM	STOP	MP	CKS[1:0]	
SCI2	BRR								
SCI2	SCR	TIE	RIE	TE	RE	MPIE	TEIE	CKE[1:0]	
SCI2	TDR								
SCI2	SSR	TDRE	RDRF	ORER	FER	PER	TEND	MPB	MPBT
SCI2	RDR								
SCI2	SCMR	BCP2	—	—	—	SDIR	SINV	—	SMIF
SMCI2	SMR	GM	BLK	PE	PM	(BCP[1:0])		CKS[1:0]	
SMCI2	BRR								
SMCI2	SCR	TIE	RIE	TE	RE	MPIE	TEIE	CKE[1:0]	
SMCI2	TDR								
SMCI2	SSR	TDRE	RDRF	ORER	ERS	PER	TEND	MPB	MPBT
SMCI2	RDR								
SMCI2	SCMR	BCP2	—	—	—	SDIR	SINV	—	SMIF
CRC	CRCCR	DORCLR	—	—	—	—	LMS	GPS[1:0]	
CRC	CRCDIR								
CRC	CRCDOR								
RIIC0	ICCR1	ICE	IICRST	CLO	SOWP	SCLO	SDAO	SCLI	SDAI
RIIC0	ICCR2	BBSY	MST	TRS	—	SP	RS	ST	—
RIIC0	ICMR1	MTWP		CKS[2:0]		BCWP		BC[2:0]	
RIIC0	ICMR2	DLCS		SDDL[2:0]		TMWE	TMOH	TMOL	TMOS
RIIC0	ICMR3	SMBS	WAIT	RDRFS	ACKWP	ACKBT	ACKBR	NF[1:0]	
RIIC0	ICFER	—	SCLE	NFE	NACKE	SALE	NALE	MALE	TMOE
RIIC0	ICSER	HOAE	—	DIDE	—	GCAE	SAR2E	SAR1E	SAR0E
RIIC0	ICIER	TIE	TEIE	RIE	NAKIE	SPIE	STIE	ALIE	TMOIE
RIIC0	ICSR1	HOA	—	DID	—	GCA	AAS2	AAS1	AAS0
RIIC0	ICSR2	TDRE	TEND	RDRF	NACKF	STOP	START	AL	TMOF
RIIC0	SARL0				SVA[6:0]				SVA0
RIIC0	TMOCNTL								
RIIC0	SARU0	—	—	—	—	—		SVA[1:0]	FS
RIIC0	TMOCNTU								
RIIC0	SARL1				SVA[6:0]				SVA0
RIIC0	SARU1	—	—	—	—	—		SVA[1:0]	FS
RIIC0	SARL2				SVA[6:0]				SVA0
RIIC0	SARU2	—	—	—	—	—		SVA[1:0]	FS
RIIC0	ICBRL	—	—	—			BRL[4:0]		
RIIC0	ICBRH	—	—	—			BRH[4:0]		
RIIC0	ICDRT								
RIIC0	ICDRR								
RSPI0	SPCR	SPRIE	SPE	SPTIE	SPEIE	MSTR	MODFEN	TXMD	SPMS

Table 4.2 List of I/O Registers (Bit Order) (13 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
S12AD0	ADRD*2	DIAGST[1:0]		—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD0	ADDR0A*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD0	ADDR1*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD0	ADDR2*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD0	ADDR3*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD0	ADDR0B*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD0	ADSSTR								
S12AD1	ADCSR	ADST	ADCS[1:0]		ADIE	CKS[1:0]		TRGE	EXTRG
S12AD1	ADANS	—	—	CH[1:0]		—	PG102SEL	PG101SEL	PG100SEL
		—	—	—	—	—	PG102EN	PG101EN	PG100EN
S12AD1	ADPG	—	—	—	—	PG102GAIN[3:0]			
		PG101GAIN[3:0]				PG100GAIN[3:0]			
S12AD1	ADCER	ADRFMT	—	ADIEW	ADIE2	DIAGM	DIAGLD	DIAGVAL[1:0]	
		—	—	ACE	—	—	ADPRC[1:0]		SHBYP
S12AD1	ADSTRGR	—	—	—	ADSTRS1[4:0]				
		—	—	—	ADSTRS0[4:0]				
S12AD1	ADRD*2	DIAGST[1:0]		—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD1	ADDR0A*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD1	ADDR1*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD1	ADDR2*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD1	ADDR3*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD1	ADDR0B*2	—	—	—	—	AD11	AD10	AD9	AD8
		AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
S12AD1	ADSSTR								
PORT1	DDR	—	—	—	—	—	—	B1	B0
PORT2	DDR	—	—	—	B4	B3	B2	B1	B0
PORT3	DDR	—	—	—	—	B3	B2	B1	B0
PORT7	DDR	—	B6	B5	B4	B3	B2	B1	B0
PORT8	DDR	—	—	—	—	—	B2	B1	B0
PORT9	DDR	—	B6	B5	B4	B3	B2	B1	B0
PORTA	DDR	—	—	B5	B4	B3	B2	B1	B0
PORTB	DDR	B7	B6	B5	B4	B3	B2	B1	B0
PORTD	DDR	B7	B6	B5	B4	B3	B2	B1	B0
PORTE	DDR	—	—	B5	B4	B3	—	B1	B0
PORTG	DDR	—	—	B5	B4	B3	B2	B1	B0
PORT1	DR	—	—	—	—	—	—	B1	B0
PORT2	DR	—	—	—	B4	B3	B2	B1	B0
PORT3	DR	—	—	—	—	B3	B2	B1	B0
PORT7	DR	—	B6	B5	B4	B3	B2	B1	B0

Table 4.2 List of I/O Registers (Bit Order) (26 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
GPT1	GTADTBRB								
GPT1	GTADTDBRB								
GPT1	GTONCR	OBE	OAE	—	SWN	—	—	—	NFV
		NFS[3:0]				NVB	NVA	NEB	NEA
GPT1	GTDTCR	—	—	—	—	—	—	—	TDFER
		—	—	TDBDE	TDBUE	—	—	—	TDE
GPT1	GTDVU								
GPT1	GTDVD								
GPT1	GTDBU								
GPT1	GTDBD								
GPT1	GTSOS	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	SOS[1:0]	
GPT1	GTSOTR	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	SOTR
GPT2	GTIOR	OBHLD	OBDFLT	GTIOB[5:0]					
		OAHLD	OADFLT	GTIOA[5:0]					
GPT2	GTINTAD	ADTRBDEN	ADTRBUEN	ADTRADEN	ADTRAUEN	EINT	—	—	—
		GTINTPR[1:0]		GTINTF	GTINTE	GTINTD	GTINTC	GTINTB	GTINTA
GPT2	GTCR	—	—	CCLR[1:0]		—	—	TPCS[1:0]	
		—	—	—	—	—	MD[2:0]		
GPT2	GTBER	—	ADTDB	ADTTB[1:0]		—	ADTDA	ADTTA[1:0]	
		—	CCRSWT	PR[1:0]		CCRB[1:0]		CCRA[1:0]	
GPT2	GTUDC	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	UDF	UD
GPT2	GTITC	—	ADTBL	—	ADTAL	—	IVTT[2:0]		
		IVTC[1:0]		ITLF	ITLE	ITLD	ITLC	ITLB	ITLA
GPT2	GTST	TUCF	—	—	—	DTEF	ITCNT[2:0]		
		TCFPU	TCFPO	TCFF	TCFE	TCFD	TCFC	TCFB	TCFA
GPT2	GTCNT								
GPT2	GTCCRA								
GPT2	GTCCRB								
GPT2	GTCCRC								
GPT2	GTCCRD								
GPT2	GTCCRE								
GPT2	GTCCRF								
GPT2	GTPR								

Table 5.4 Permissible Output Currents

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit
Permissible output low current (average value per pin)	I_{OL}	-	-	2.0*1	mA
Permissible output low current (max. value per pin)	I_{OL}	-	-	4.0*1	mA
Permissible output low current (total)	ΣI_{OL}	-	-	110	mA
Permissible output high current (average value per pin)	$-I_{OH}$	-	-	2.0*1	mA
Permissible output high current (max. value per pin)	$-I_{OH}$	-	-	4.0*1	mA
Permissible output high current (total)	$\Sigma -I_{OH}$	-	-	35	mA

Caution: To protect the LSI's reliability, the output current values should not exceed the permissible output current.

Note 1. I_{OL} = 15 mA (max.)/ $-I_{OH}$ = 5 mA (max.) for P71 to P76 and P90 to P95. Note, however, that up to 6 (112-pin or 100-pin LQFP) or 3 (80-pin or 64-pin LQFP) pins can accept over 2.0-mA I_{OL} / $-I_{OH}$ at the same time.

Table 5.5 Permissible Power Consumption (Only for G Version)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Typ.	Max.	Unit	Test Conditions
Total permissible power consumption*1	Pd	—	325	mW	85°C < Ta ≤ 105°C

Note: • Please contact Renesas Electronics sales office for derating of operation under Ta = +85°C to +105°C. Derating is the systematic reduction of load for improved reliability.

Note 1. The total power consmuption of the whole chip including output current.

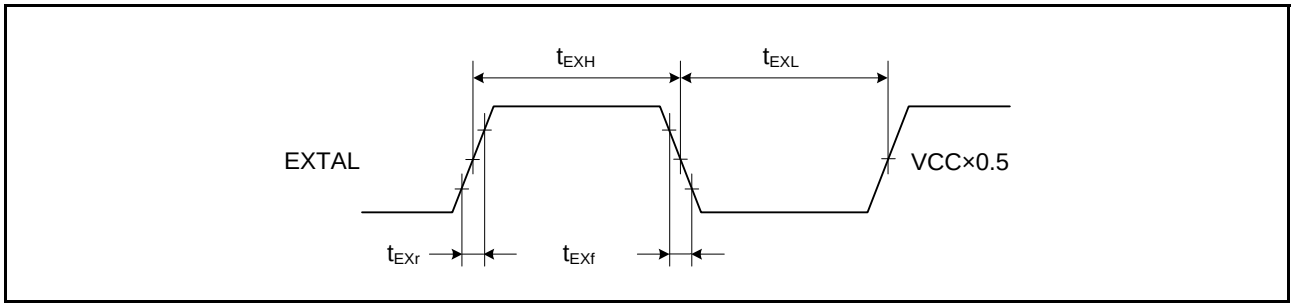

Figure 5.4 EXTAL External Input Clock Timing

5.3.3 Timing of On-Chip Peripheral Modules

Table 5.9 Timing of On-Chip Peripheral Modules (1)

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item			Symbol	Min.	Typ.	Max.	Unit
SCI	Input clock cycle	Asynchronous	t_{Scyc}	$4 \times t_{Pcyc}$	-	ns	Figure 5.8
		Clock synchronous		$6 \times t_{Pcyc}$	-		
	Input clock pulse width		t_{SCKW}	$0.4 \times t_{Pcyc}$	$0.6 \times t_{Scyc}$	ns	
	Input clock rise time		t_{SCKr}	-	20	ns	
	Input clock fall time		t_{SCKf}	-	20	ns	
	Output clock cycle	Asynchronous	t_{Scyc}	$16 \times t_{Pcyc}$	-	ns	
		Clock synchronous		$6 \times t_{Pcyc}$	-	ns	
	Output clock pulse width		t_{SCKW}	$0.4 \times t_{Scyc}$	$0.6 \times t_{Scyc}$	ns	
	Output clock rise time		t_{SCKr}	-	20	ns	
	Output clock fall time		t_{SCKf}	-	20	ns	
	Transmit data delay time (clock synchronous)		t_{TXD}	-	40	ns	Figure 5.9
	Receive data setup time (clock synchronous)		t_{RXS}	40	-	ns	
	Receive data hold time (clock synchronous)		t_{RXH}	40	-	ns	

Note: • t_{Pcyc}: PCLK cycle

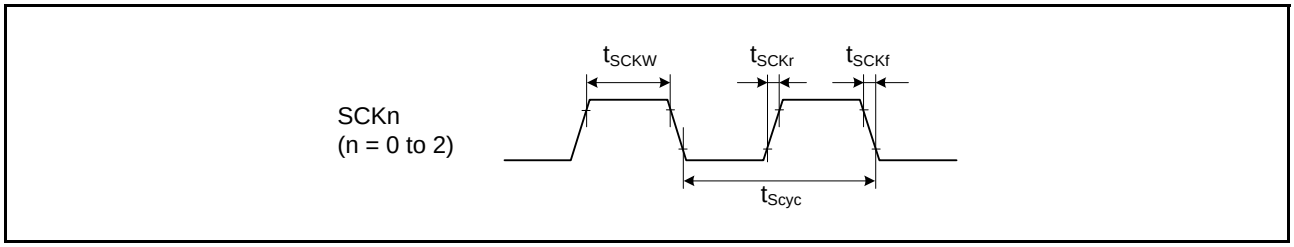

Figure 5.8 SCK Clock Input Timing

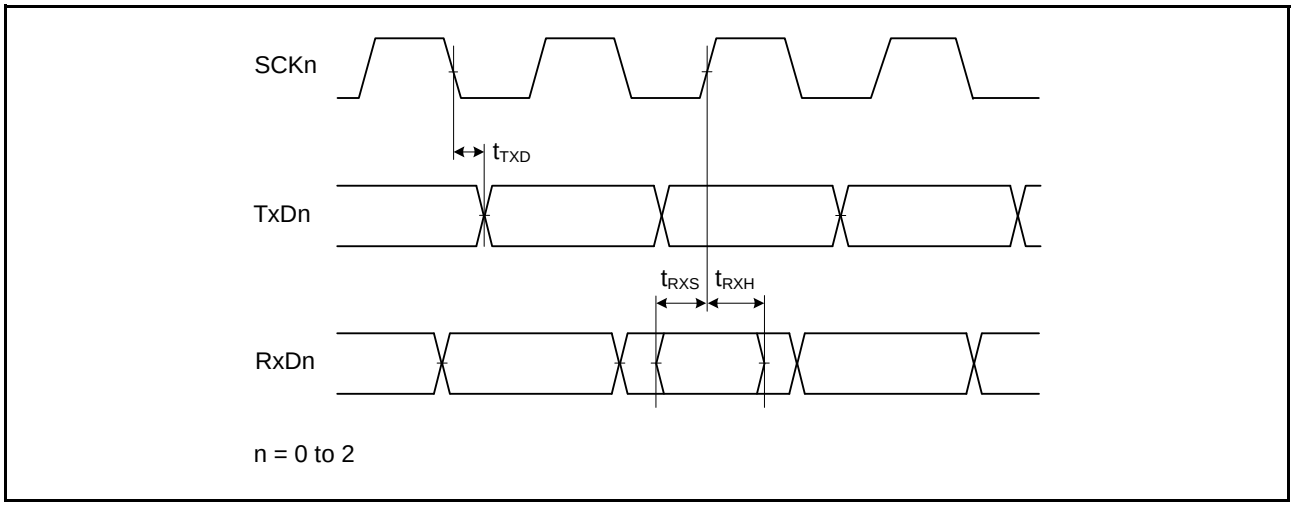

Figure 5.9 SCI Input/Output Timing: Clock Synchronous Mode

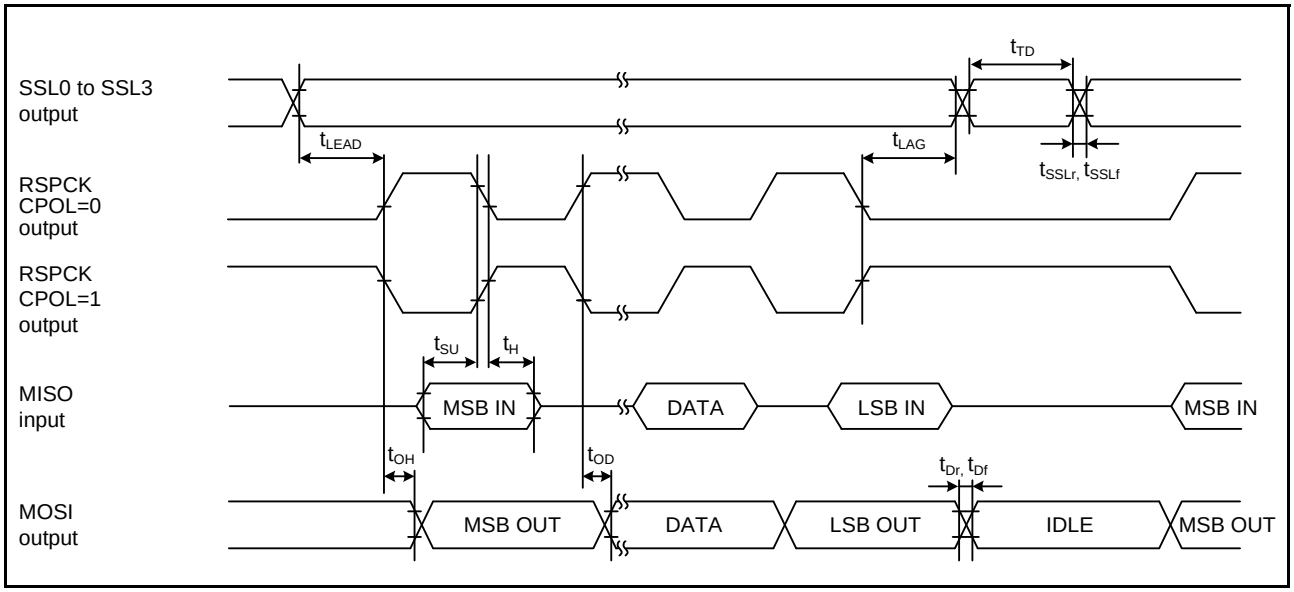

Figure 5.13 RSPI Timing (Master, CPHA = 1)

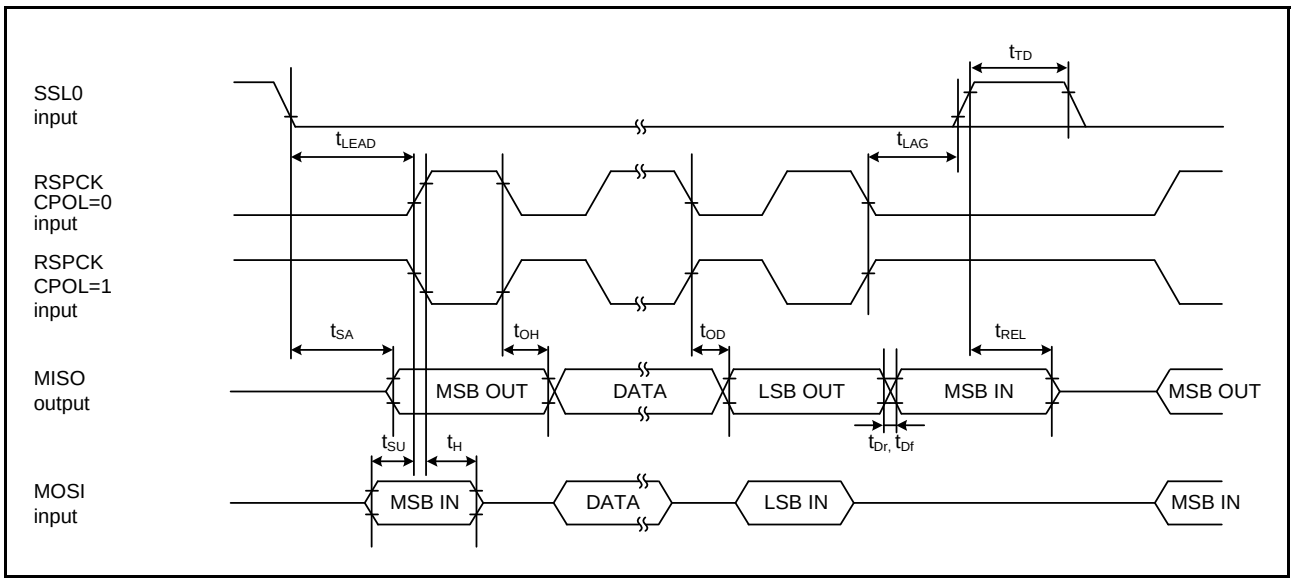

Figure 5.14 RSPI Timing (Slave, CPHA = 0)

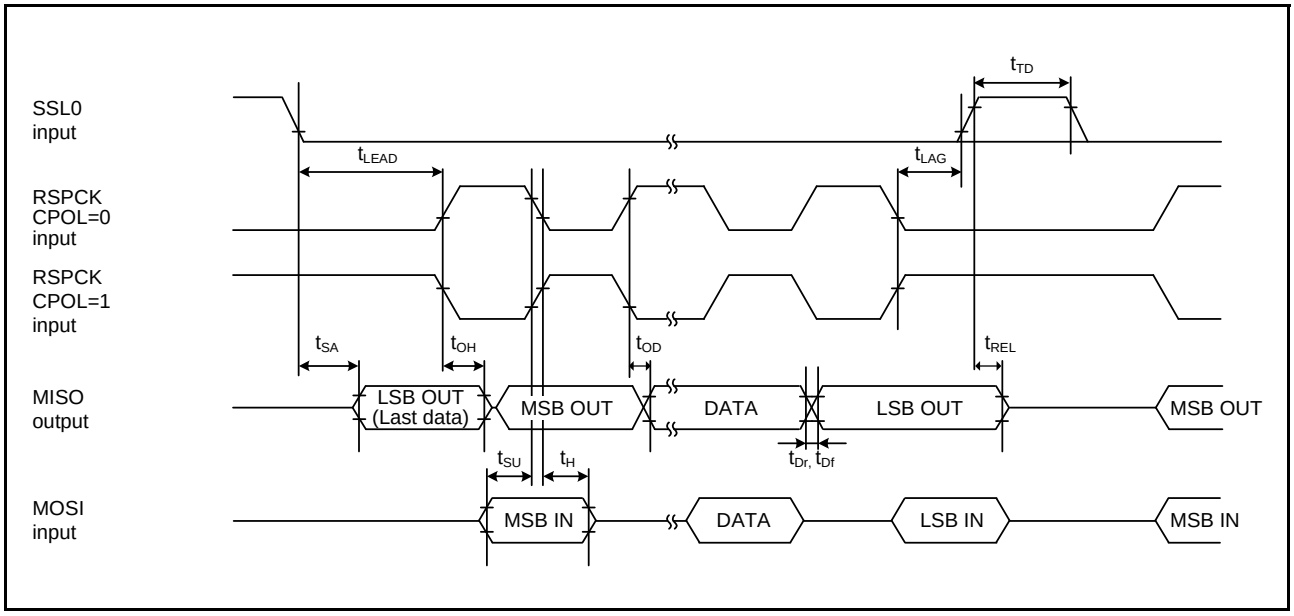

Figure 5.15 RSPI Timing (Slave, CPHA = 1)

5.7 ROM (Flash Memory for Code Storage) Characteristics

Table 5.21 ROM (Flash Memory for Code Storage) Characteristics (1)

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Temperature range for the programming/erasure operation:
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Rewrite/erase cycle*1	N_{PEC}	1000	—	—	Times	
Data hold time	t_{DRP}	30*2	—	—	Year	Ta = +85C°

Note 1. Definition of rewrite/erase cycle:
The rewrite/erase cycle is the number of erasing for each block. When the rewrite/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 256-byte writing is performed 16 times for different addresses in 4-Kbyte block and then the entire block is erased, the rewrite/erase cycle is counted as one. However, writing to the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. The value is obtained from the reliability test.

Table 5.22 ROM (Flash Memory for Code Storage) Characteristics (2)

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Temperature range for the programming/erasure operation:
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Programming time	256 bytes	t_{P256}	—	2	12	ms	PCLK = 50 MHz $N_{PEC} \leq 100$
	4 Kbytes	t_{P4K}	—	23	50	ms	
	16 Kbytes	t_{P16K}	—	90	200	ms	
	256 byte	t_{P256}	—	2.4	14.4	ms	PCLK = 50 MHz $N_{PEC} > 100$
	4 Kbytes	t_{P4K}	—	27.6	60	ms	
	16 Kbytes	t_{P16K}	—	108	240	ms	
Erasure time	4 Kbytes	t_{E4K}	—	25	60	ms	PCLK = 50 MHz $N_{PEC} \leq 100$
	16 Kbytes	t_{E16K}	—	100	240	ms	
	4 Kbytes	t_{E4K}	—	30	72	ms	PCLK = 50 MHz $N_{PEC} > 100$
	16 Kbytes	t_{E16K}	—	120	288	ms	
Suspend delay time during writing		t_{SPD}	—	—	120	µs	Figure 5.24 PCLK = 50 MHz
First suspend delay time during erasing (in suspend priority mode)		t_{SESD1}	—	—	120	µs	
Second suspend delay time during erasing (in suspend priority mode)		t_{SESD2}	—	—	1.7	ms	
Suspend delay time during erasing (in erasure priority mode)		t_{SEED}	—	—	1.7	ms	

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

   — The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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